

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







# HI2220R301R-10

# UNCONTROLLED DOCUMENT

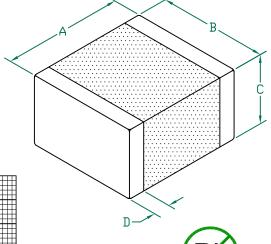
#### PHYSICAL DIMENSIONS:

A 5.59 [.220] ± 0.51 [.020]

B 5.08 [.200] ± 0.25 [.010]

C 3.20 [.126] ± 0.25 [.010]

D 0.76 [.030] ± 0.25 [.010]

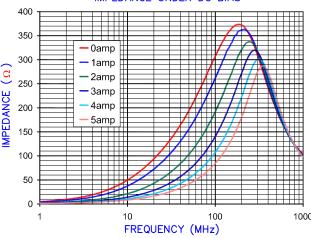


ELECTRICAL CHARACTERISTICS:									
Z @ 100MHz $\left(\begin{array}{c}\Omega\end{array}\right)$		DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current						
Nominal	300								
Minimum	225								
Maximum	375	0.020	5000 mA						

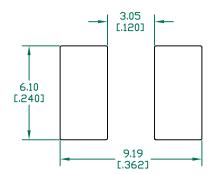
NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2,000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATEING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)

### Z vs. FREQUENCY IMPEDANCE UNDER DC BIAS

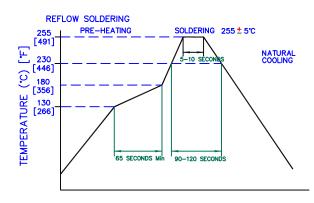


#### LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [0.030] to this dimension)

#### RECOMMENDED SOLDERING CONDITIONS



400	Z  , R, A	ND XL vs. F	REQUENCY		
400					
350					
350					
300			<b>\                                    </b>	####	
2 050					
250					
CG 250 D 200 D 150		- / / /	<del>                                      </del>	#####	
♀ <sup>200</sup> —		///			
₹ <sub>450</sub>		/ / /	<del>                                     </del>	#####	
☐ <sup>150</sup>					
<u> </u>		/ / / / / / /	7		
≥ 100		/////		####	
		<del>/                                      </del>			
50				####	
			R		
0		<del></del>	<del></del>		
1	10	100	1000	10000	
	FREQUENCY (MHz)				
	Z	R	XL		

RO 5 2002/95/EC

<i>,</i> u	iis differision)							
DIMENSIONS ARE IN mm [INCHES].				This print is the property of Laird				
				Tech. and is loaned in confidence subject to return upon request ar	nd		-	1
				with the understanding that no copies shall be made without the		.a	ir(	
				written consent of Laird Tech. All			`	
				rights to design or invention are reserved.				
				PROJECT/PART NUMBER:	REV	PART T	PE:	DRAWN BY:
С	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	HI2220R301R-10	С	co-	-FIRE	тмв
В	UPDATE COMPANY LOGO ADD ROHS	01/28/08	JRK		CÁLE: N	ITS	SHEET:	
Α	ORIGINAL DRAFT	04/03/04	TMB	CAD #	OOL #		2	of 2
REV	DESCRIPTION	DATE	INT	HI2220R301R-10-C	7	-		01 2

AGILENT E4991A RF Impedance/Material Analyzer HP 16092A Test Fixture. TEST REF. 3185